Appl. No. 10/712,774

Amdt. dated February 28, 2006

Reply to Office Action of November 29, 2005

Amendments to the Specification:

Please replace the paragraph that begins at line 20 of page 11 and ends at line 5 of page 12 with

the following amended paragraph:

The device for protection from impulse surges as described above is developed as an offset

connection placed in a housing with N-Type thread connectors. A micro-strip board comprises foil-

clad high frequency material RO4003 of 1 mm depth is mounted in the housing. The high

frequency line comprises a 2,34 mm thick foil strip at two gaps of which high power high

Q, ERF22X5C2H3R3CD01B (see Murata's catalogue "Chip Monolithic Ceramic Capacitors"

Cat.No.C02E-8, p.58) type capacitors are mounted. The second inductance coil L2 comprises a

microstrip section of 0.25 mm width foil, the other end of which is grounded, is linked to a node

connecting the capacitors.

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